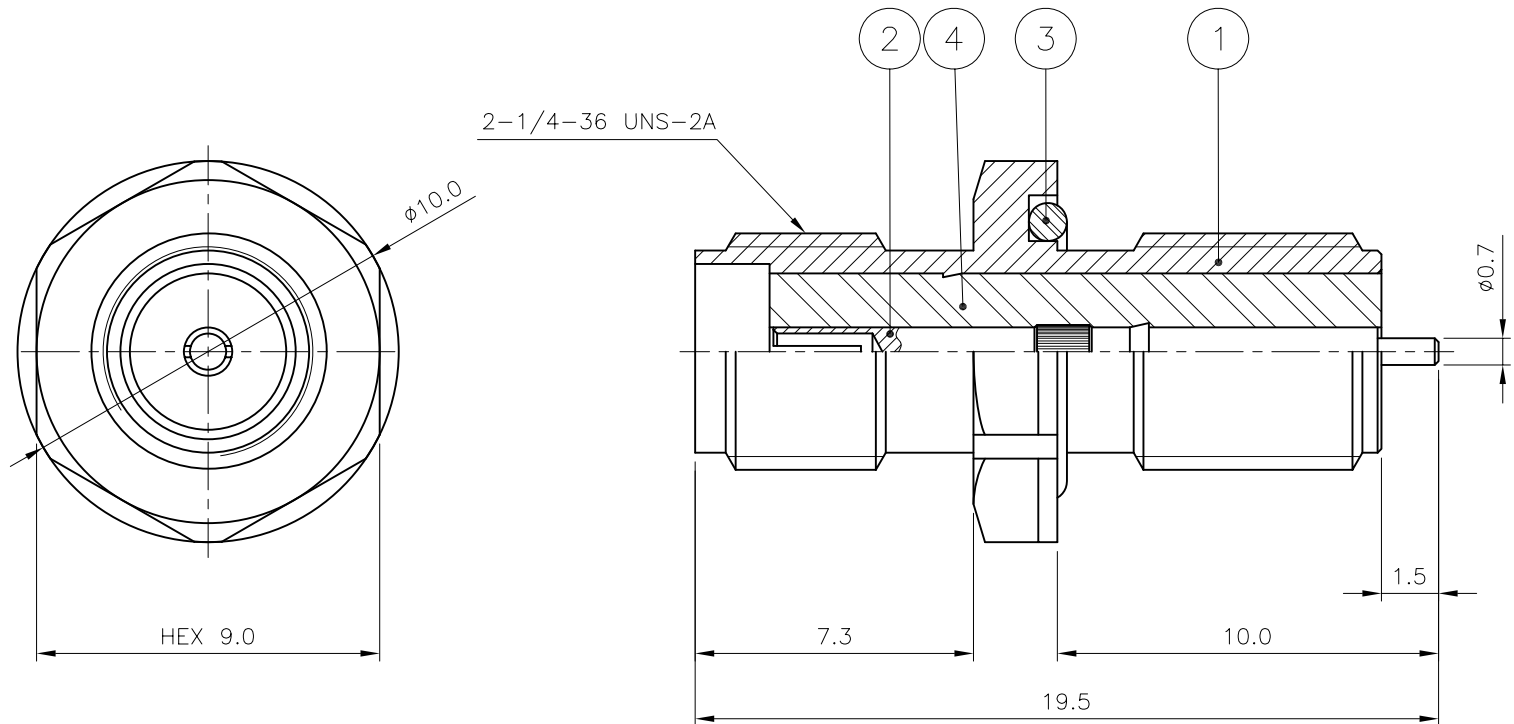


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	I.C.KIM	I.C.KIM	2014.11.25.



4	INSULATOR	1	TEFLON		DIN02203-N/1
3	GASKET	1	NBR		DGK00019-N/1
2	CONTACT	1	BeCu	Gold Plate (0.4 μ m)	DCT03299-5/1
1	BODY	1	MBsBD	Nickel Plate (5 μ m)	DBD03779-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2014. 11. 25.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY		
MATERIAL		CHECKED BY		KJ COMTECH CO.,LTD. TITLE SMA50 SOLDER END JB (F/F)
		DRAWN BY	I.C.KIM	
FINISH		SCALE	5/1	A4 DWG NO. CN03341-7/1 REVISION I R SHEET 1 of 1
		UNIT	mm	